



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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# Technical Data Sheet

## 5mm Infrared LED, T-1 3/4

### SIR383C

#### Features

- High reliability
- 2.54mm lead spacing
- Low forward voltage
- Good spectral matching to Si photodetector
- Pb free
- The product itself will remain within RoHS compliant version.



#### Descriptions

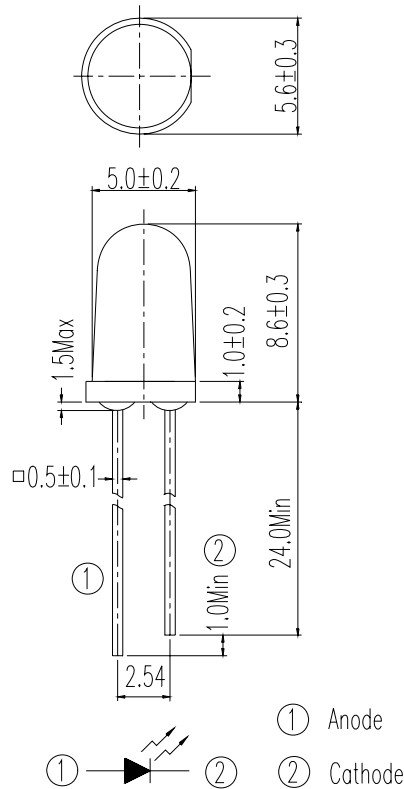
- EVERLIGHT'S Infrared Emitting Diode(SIR383C) is a high intensity diode , molded in a water clear plastic package.
- The device is spectrally matched with phototransistor , photodiode and infrared receiver module.

#### Applications

- Free air transmission system
- Optoelectronic switch
- Floppy disk drive
- Infrared applied system
- Smoke detector

#### Device Selection Guide

LED Part No.	Chip	Lens Color
	Material	
SIR	GaAlAs	Water clear

**Package Dimensions**


- Notes:** 1.All dimensions are in millimeters  
 2.Tolerances unless dimensions  $\pm 0.25\text{mm}$

**Absolute Maximum Ratings ( $T_a=25^\circ\text{C}$ )**

Parameter	Symbol	Rating	Units
Continuous Forward Current	$I_F$	100	mA
Peak Forward Current *1	$I_{FP}$	1.0	A
Reverse Voltage	$V_R$	5	V
Operating Temperature	$T_{opr}$	-40 ~ +85	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-40 ~ +85	$^\circ\text{C}$
Soldering Temperature *2	$T_{sol}$	260	$^\circ\text{C}$
Power Dissipation at(or below) 25 $^\circ\text{C}$ Free Air Temperature	$P_d$	150	mW

**Notes:** \*1: $I_{FP}$  Conditions--Pulse Width  $\leq 100 \mu\text{s}$  and Duty  $\leq 1\%$ .

\*2:Soldering time  $\leq 5$  seconds.

**Electro-Optical Characteristics (Ta=25°C)**

Parameter	Symbol	Condition	Min.	Typ.	Max.	Units
Radiant Intensity	E <sub>e</sub>	I <sub>F</sub> =20mA	11	20	--	mW/sr
		I <sub>F</sub> =100mA Pulse Width ≤ 100 μs and Duty ≤ 1%	--	95	--	
		I <sub>F</sub> =1A Pulse Width ≤ 100 μs and Duty ≤ 1%	--	950	--	
Peak Wavelength	λ <sub>p</sub>	I <sub>F</sub> =20mA	--	875	--	nm
Spectral Bandwidth	Δλ	I <sub>F</sub> =20mA	--	80	--	nm
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> =20mA	--	1.3	1.6	V
		I <sub>F</sub> =100mA Pulse Width ≤ 100 μs and Duty ≤ 1%	--	1.4	1.8	
		I <sub>F</sub> =1A Pulse Width ≤ 100 μs and Duty ≤ 1%	--	2.6	4.0	
Reverse Current	I <sub>R</sub>	V <sub>R</sub> =5V	--	--	10	μA
View Angle	2θ <sub>1/2</sub>	I <sub>F</sub> =20mA	--	20	--	deg

**Typical Electro-Optical Characteristics Curves**

Fig.1 Forward Current vs. Ambient Temperature

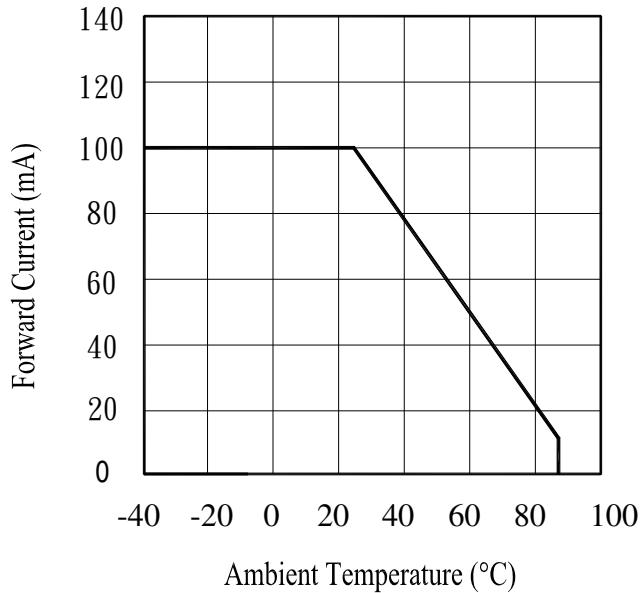


Fig.2 Spectral Distribution

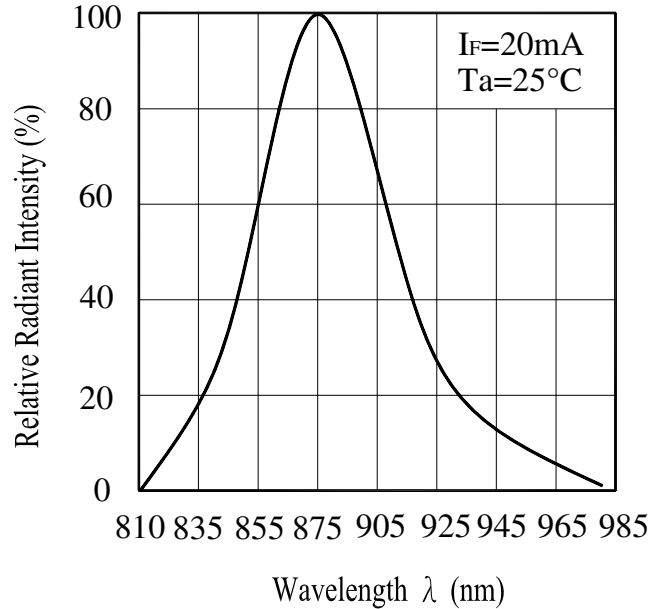


Fig.3 Peak Emission Wavelength

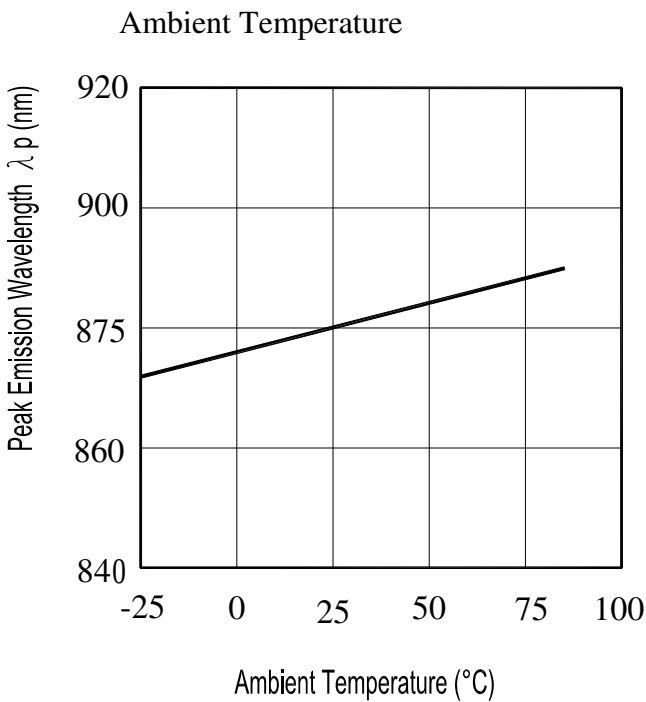
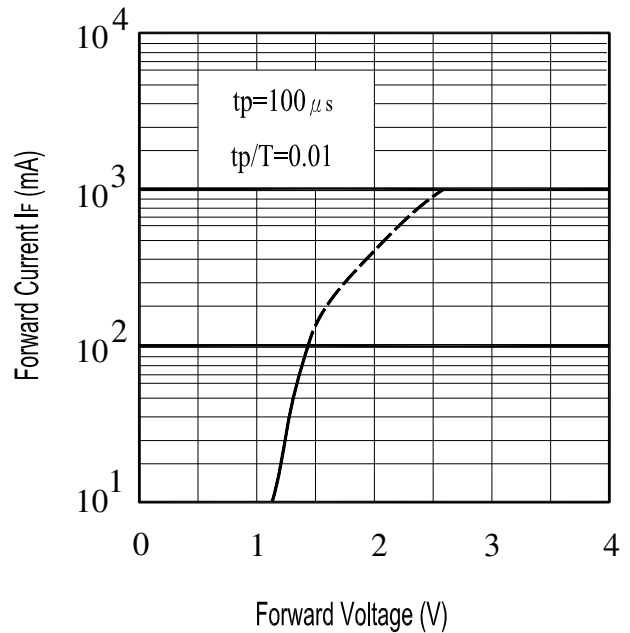


Fig.4 Forward Current vs. Forward Voltage



**Typical Electro-Optical Characteristics Curves**

Fig.5 Relative Intensity vs. Forward Current

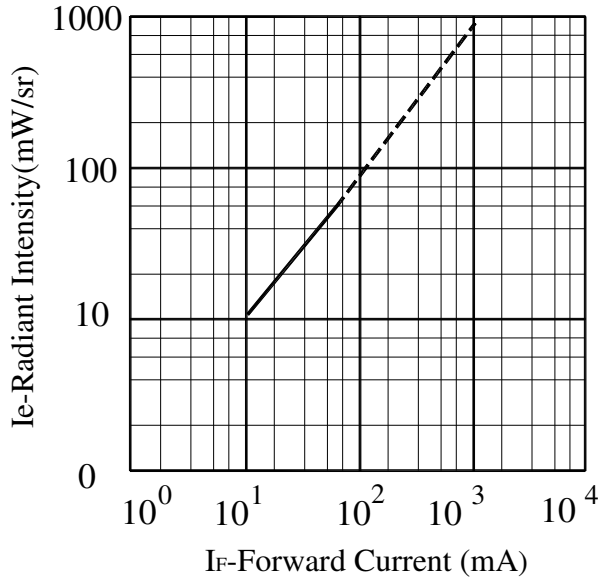


Fig.6 Relative Radiant Intensity vs. Angular Displacement

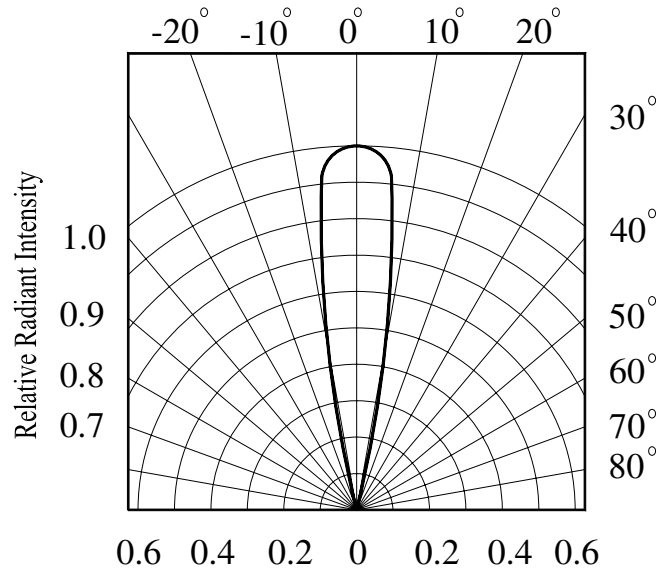


Fig.7 Relative Intensity vs. Ambient Temperature(°C)

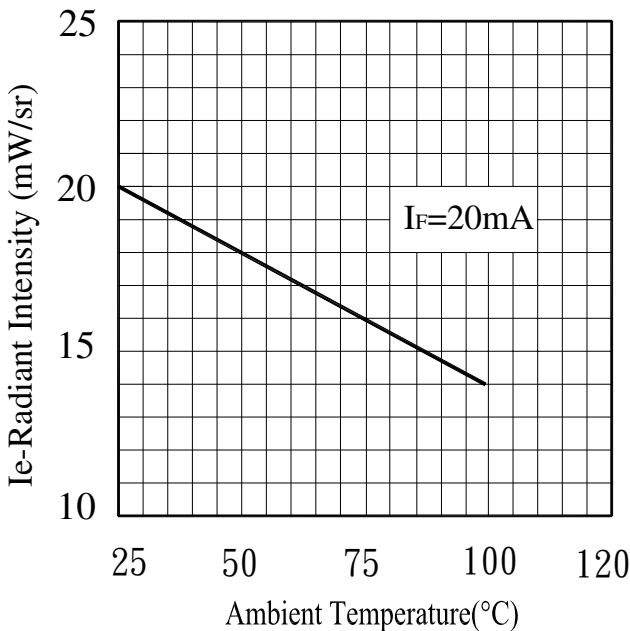
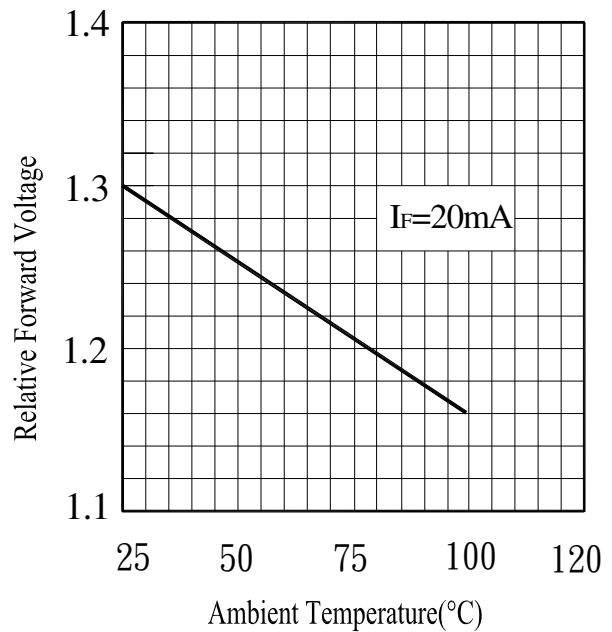


Fig.8 Forward Voltage vs. Ambient Temperature(°C)



**Reliability Test Item And Condition**

The reliability of products shall be satisfied with items listed below.

Confidence level : 90%

LTPD : 10%

NO.	Item	Test Conditions	Test Hours/ Cycles	Sample Sizes	Failure Judgement Criteria	Ac/Re
1	Solder Heat	TEMP. : 260°C±5°C	10secs	22pcs	$I_R \geq U \times 2$ $E_e \leq L \times 0.8$ $V_F \geq U \times 1.2$  U : Upper Specification  Limit L : Lower Specification Limit	0/1
2	Temperature Cycle	H : +100°C    15mins $\updownarrow$ 5mins L : -40°C    15mins	300Cycles	22pcs		0/1
3	Thermal Shock	H : +100°C    5mins $\updownarrow$ 10secs L : -10°C    5mins	300Cycles	22pcs		0/1
4	High Temperature Storage	TEMP. : +100°C	1000hrs	22pcs		0/1
5	Low Temperature Storage	TEMP. : -40°C	1000hrs	22pcs		0/1
6	DC Operating Life	$I_F = 20\text{mA}$	1000hrs	22pcs		0/1
7	High Temperature/ High Humidity	85°C / 85% R.H	1000hrs	22pcs		0/1



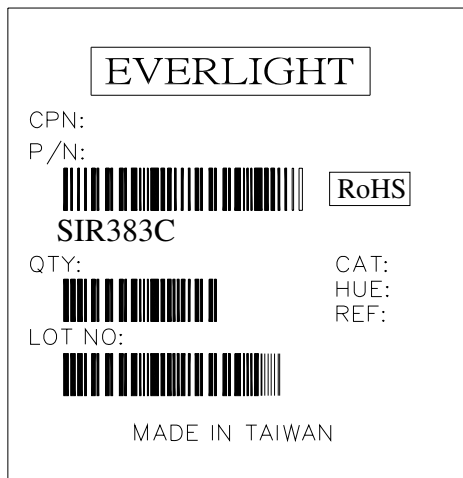
**SIR383C**

## Packing Quantity Specification

1.500PCS/1Bag , 5Bags/1Box

2.10Boxes/1Carton

## Label Form Specification



CPN: Customer's Production Number

P/N : Production Number

QTY: Packing Quantity

CAT: Ranks

HUE: Peak Wavelength

REF: Reference

LOT No: Lot Number

MADE IN TAIWAN: Production Place

## Notes

1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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